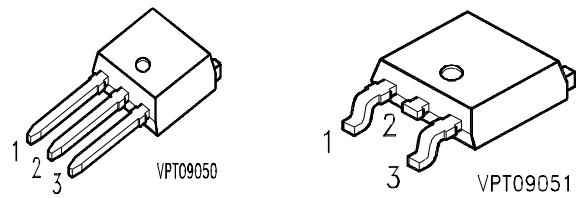


SIPMOS® Power Transistor

- N channel
- Enhancement mode
- Logic Level
- Avalanche-rated
- dv/dt rated
- 175°C operating temperature



Pin 1	Pin 2	Pin 3
G	D	S

Type	V _{DS}	I _D	R _{DS(on)}	Package	Ordering Code
SPD28N05L	55 V	28 A	0.05 Ω	P-TO252	Q67040 - S4122 - A2
SPU28N05L	55 V	28 A	0.05 Ω	P-TO251	Q67040 - S4114 - A2

Maximum Ratings

Parameter	Symbol	Values	Unit
Continuous drain current	I _D	28	A
T _C = 25 °C		20	
T _C = 100 °C			
Pulsed drain current	I _{Dpuls}	112	
T _C = 25 °C			
Avalanche energy, single pulse	E _{AS}		mJ
I _D = 28 A, V _{DD} = 25 V, R _{GS} = 25 Ω			
L = 357 μH, T _j = 25 °C		140	
Avalanche current, limited by T _{jmax}	I _{AR}	28	A
Avalanche energy, periodic limited by T _{jmax}	E _{AR}	7.5	mJ
Reverse diode dv/dt	dv/dt		kV/μs
I _S = 30 A, V _{DS} = 40 V, di _F /dt = 200 A/μs			
T _{jmax} = 175 °C		6	
Gate source voltage	V _{GS}	± 14	V
Power dissipation	P _{tot}		W
T _C = 25 °C		75	

Maximum Ratings

Parameter	Symbol	Values	Unit
Operating temperature	T_j	-55 ... + 175	°C
Storage temperature	T_{stg}	-55 ... + 175	
Thermal resistance, junction - case	R_{thJC}	≤ 2	K/W
Thermal resistance, junction - ambient (PCB mount)**	R_{thJA}	≤ 50	
Thermal resistance, junction - ambient	R_{thJA}	≤ 100	
IEC climatic category, DIN IEC 68-1		55 / 175 / 56	

** when mounted on 1 " square PCB (FR4);for recommended footprint

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Drain- source breakdown voltage $V_{GS} = 0 \text{ V}, I_D = 0.25 \text{ mA}, T_j = 25^\circ\text{C}$	$V_{(BR)DSS}$	55	-	-	V
Gate threshold voltage $V_{GS}=V_{DS}, I_D = 50 \mu\text{A}$	$V_{GS(\text{th})}$	1.2	1.6	2	
Zero gate voltage drain current $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, T_j = -40^\circ\text{C}$	I_{DSS}	-	-	0.1	μA
$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25^\circ\text{C}$		-	0.1	1	
$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 150^\circ\text{C}$		-	-	100	
Gate-source leakage current $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	I_{GSS}	-	10	100	nA
Drain-Source on-resistance $V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	$R_{DS(\text{on})}$	-	0.04	0.05	Ω
$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		-	0.025	0.03	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Dynamic Characteristics					
Transconductance $V_{DS} \geq 2 * I_D * R_{DS(on)max}$, $I_D = 20 \text{ A}$	g_{fs}	10	20	-	S
Input capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{iss}	-	770	960	pF
Output capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{oss}	-	230	300	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{rss}	-	130	165	
Turn-on delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 28 \text{ A}$ $R_G = 6.8 \Omega$	$t_{d(on)}$	-	10	15	ns
Rise time $V_{DD} = 30 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 28 \text{ A}$ $R_G = 6.8 \Omega$	t_r	-	75	115	
Turn-off delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 28 \text{ A}$ $R_G = 6.8 \Omega$	$t_{d(off)}$	-	30	45	
Fall time $V_{DD} = 30 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 28 \text{ A}$ $R_G = 6.8 \Omega$	t_f	-	20	30	
Gate charge at threshold $V_{DD} = 40 \text{ V}$, $I_D \geq 0.1 \text{ A}$, $V_{GS} = 0 \text{ to } 1 \text{ V}$	$Q_{g(th)}$	-	1	1.5	nC
Gate charge at 5.0 V $V_{DD} = 40 \text{ V}$, $I_D = 28 \text{ A}$, $V_{GS} = 0 \text{ to } 5 \text{ V}$	$Q_{g(5)}$	-	20	30	
Gate charge total $V_{DD} = 40 \text{ V}$, $I_D = 28 \text{ A}$, $V_{GS} = 0 \text{ to } 10 \text{ V}$	$Q_{g(total)}$	-	32	50	
Gate plateau voltage $V_{DD} = 40 \text{ V}$, $I_D = 28 \text{ A}$	$V_{(plateau)}$	-	4	-	V

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

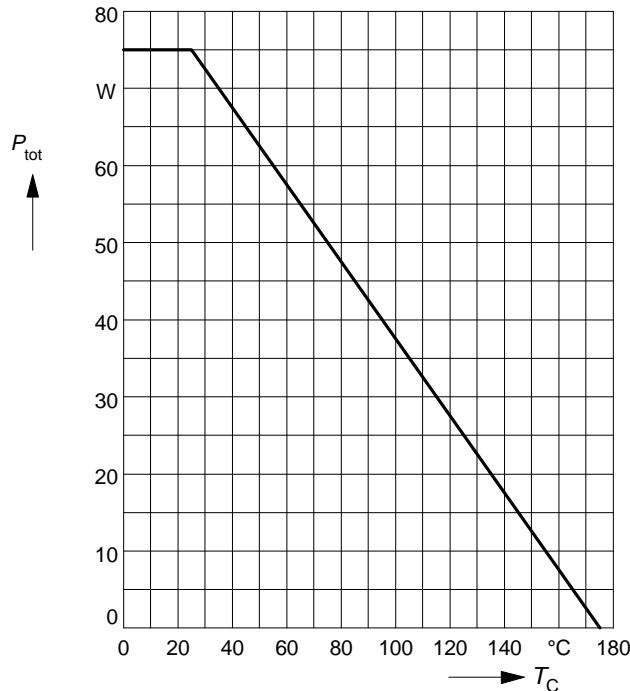
Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Reverse Diode

Inverse diode continuous forward current $T_C = 25^\circ\text{C}$	I_S	-	-	28	A
Inverse diode direct current,pulsed $T_C = 25^\circ\text{C}$	I_{SM}	-	-	112	
Inverse diode forward voltage $V_{GS} = 0 \text{ V}, I_F = 56 \text{ A}$	V_{SD}	-	1.1	1.8	V
Reverse recovery time $V_R = 30 \text{ V}, I_F=I_S, di_F/dt = 100 \text{ A}/\mu\text{s}$	t_{rr}	-	60	90	ns
Reverse recovery charge $V_R = 30 \text{ V}, I_F=I_S, di_F/dt = 100 \text{ A}/\mu\text{s}$	Q_{rr}	-	0.15	0.25	μC

Power dissipation

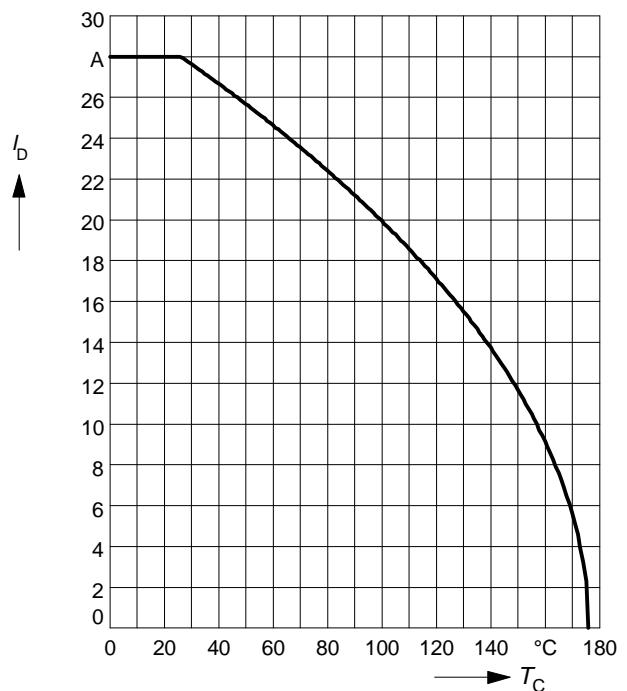
$$P_{\text{tot}} = f(T_C)$$



Drain current

$$I_D = f(T_C)$$

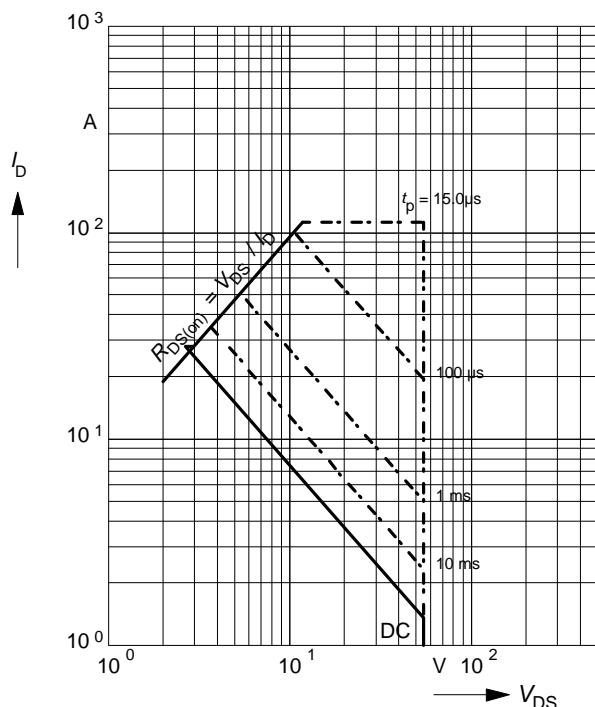
parameter: $V_{GS} \geq 4$ V



Safe operating area

$$I_D = f(V_{DS})$$

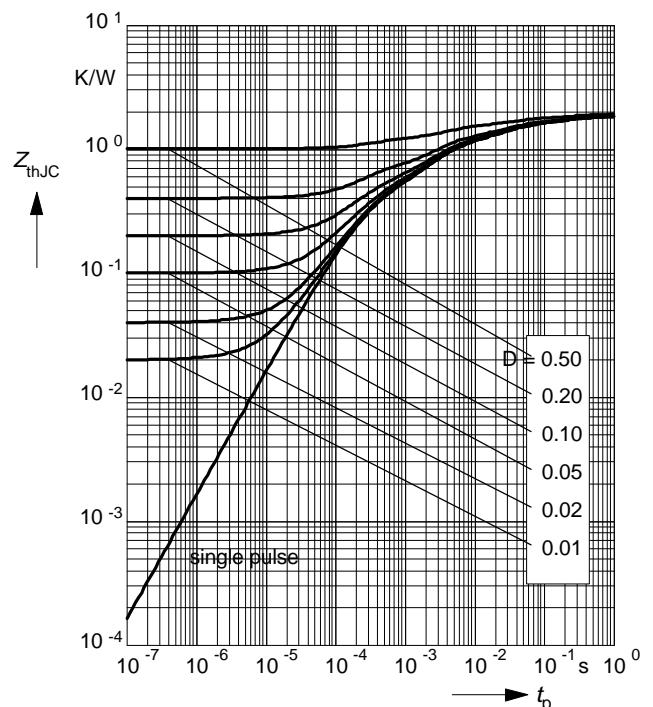
parameter: $D = 0$, $T_C = 25^\circ\text{C}$



Transient thermal impedance

$$Z_{\text{thJC}} = f(t_p)$$

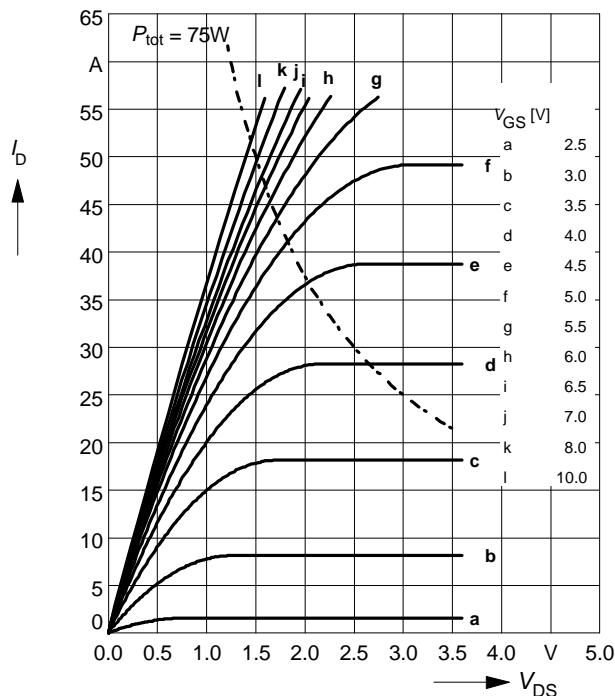
parameter: $D = t_p / T$



Typ. output characteristics

$$I_D = f(V_{DS})$$

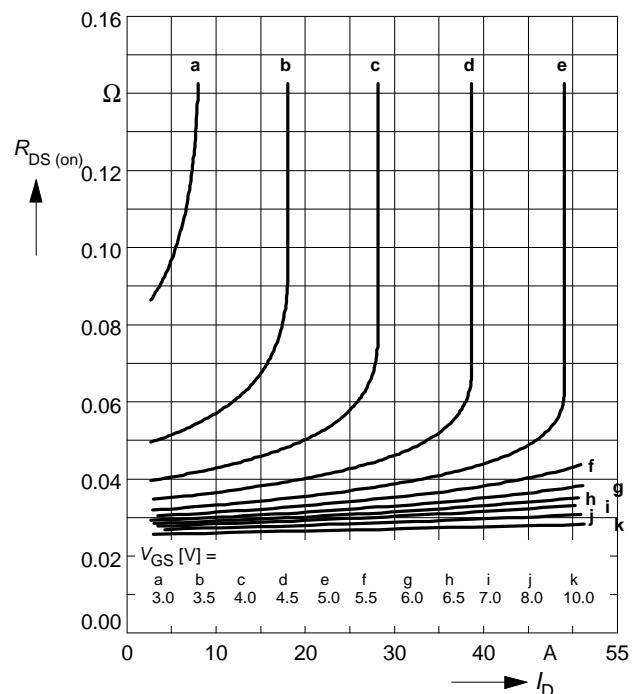
parameter: $t_p = 80 \mu\text{s}$, $T_j = 25^\circ\text{C}$



Typ. drain-source on-resistance

$$R_{DS(on)} = f(I_D)$$

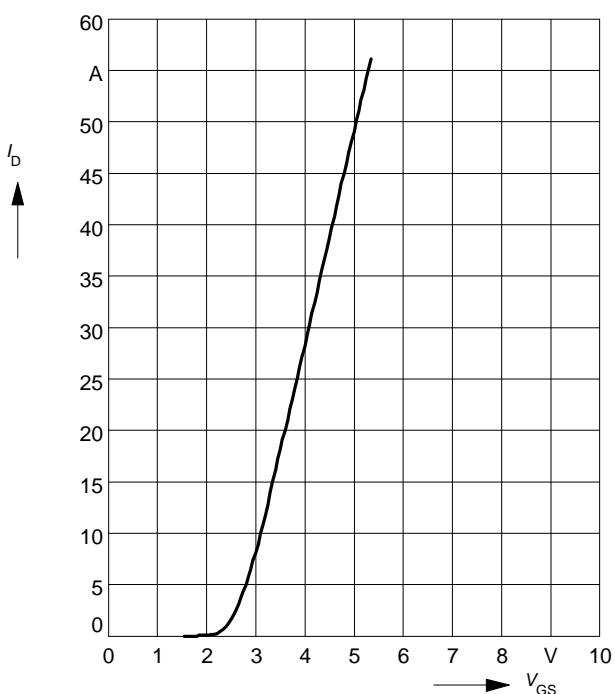
parameter: $t_p = 80 \mu\text{s}$, $T_j = 25^\circ\text{C}$



Typ. transfer characteristics $I_D = f(V_{GS})$

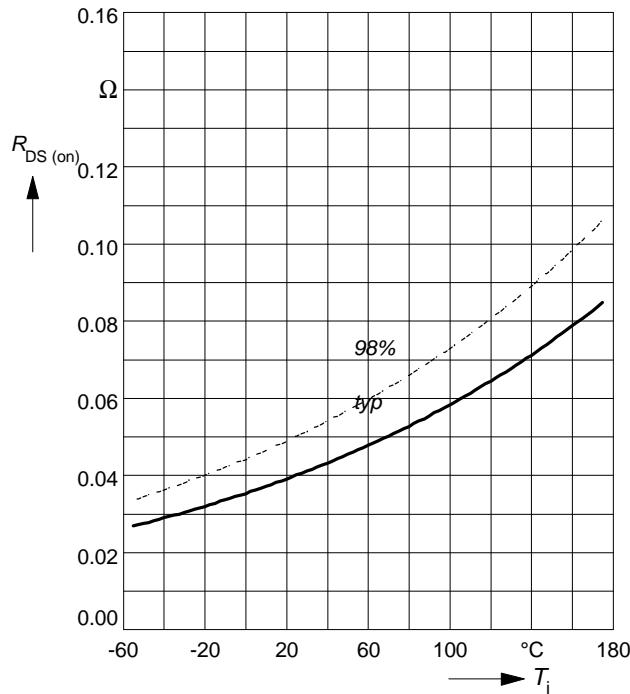
parameter: $t_p = 80 \mu\text{s}$

$$V_{DS} \geq 2 \times I_D \times R_{DS(on)\max}$$



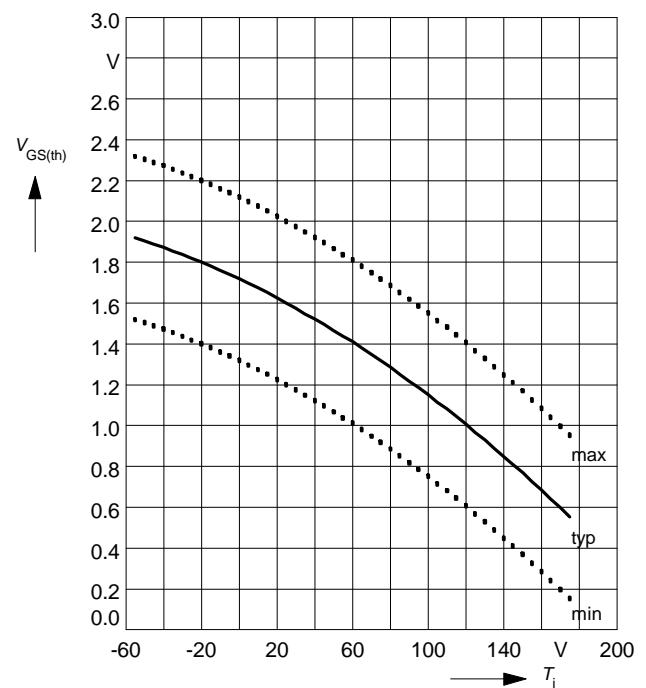
Drain-source on-resistance

$R_{DS(on)} = f(T_j)$
parameter: $I_D = 20 \text{ A}$, $V_{GS} = 4.5 \text{ V}$



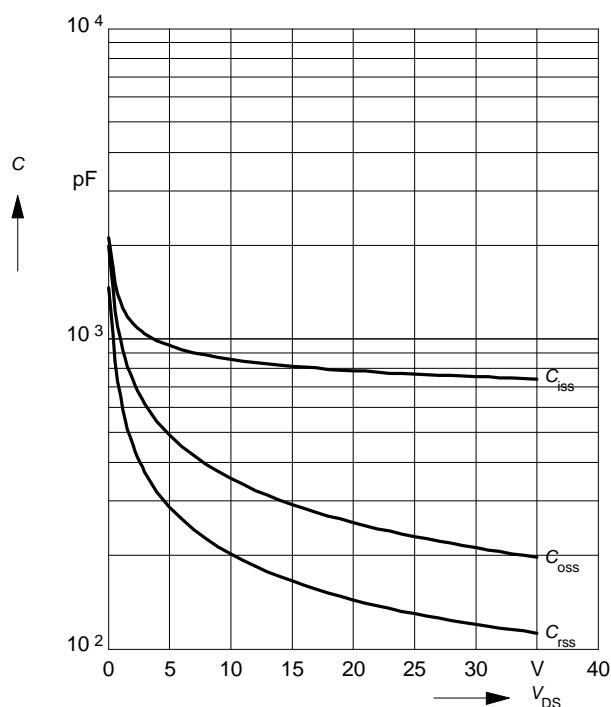
Gate threshold voltage

$V_{GS(th)} = f(T_j)$
parameter: $V_{GS} = V_{DS}$, $I_D = 50 \mu\text{A}$



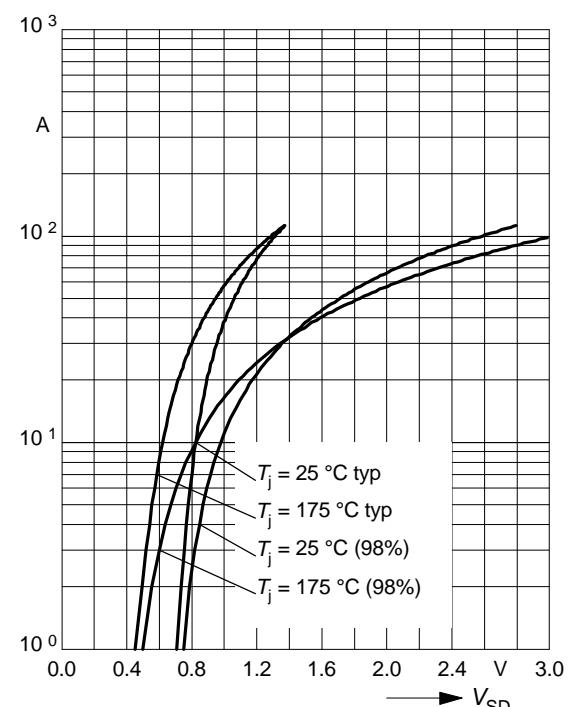
Typ. capacitances

$C = f(V_{DS})$
parameter: $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$



Forward characteristics of reverse diode

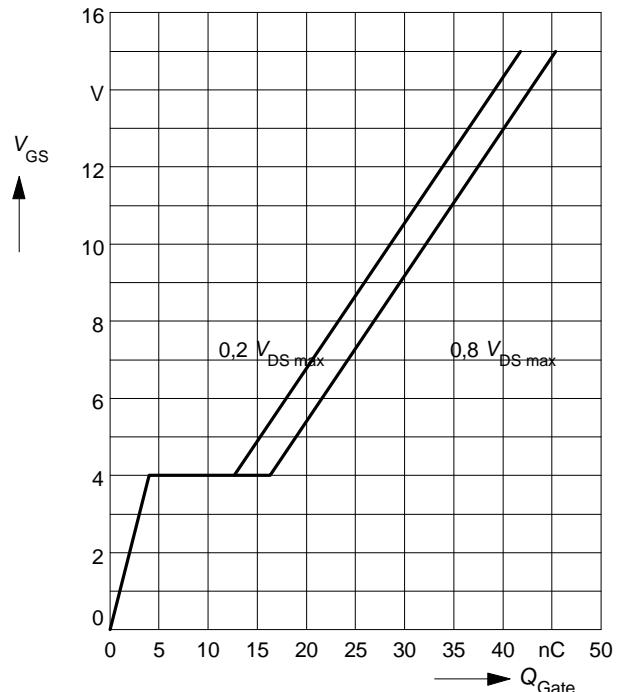
$I_F = f(V_{SD})$
parameter: T_j , $t_p = 80 \mu\text{s}$



Typ. gate charge

$$V_{GS} = f(Q_{Gate})$$

parameter: I_D puls = 28 A



Drain-source breakdown voltage

$$V_{(BR)DSS} = f(T_j)$$

